

2SD1367

Silicon NPN Epitaxial

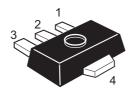
REJ03G0785-0200 (Previous ADE-208-1147) Rev.2.00 Aug.10.2005

Application

- Low frequency power amplifier
- Complementary pair with 2SB1001

Outline

RENESAS Package code: PLZZ0004CA-A (Package name: UPAK $^{\textcircled{R}})$



- 1. Base
- 2. Collector
- 3. Emitter
- 4. Collector (Flange)

Note: Marking is "BC".

*UPAK is a trademark of Renesas Technology Corp.

Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	20	V
Collector to emitter voltage	V_{CEO}	16	V
Emitter to base voltage	V_{EBO}	6	V
Collector current	I _C	2	Α
Collector peak current	i _{C(peak)} *1	3	Α
Collector power dissipation	Pc*2	1	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 ms, Duty cycle \leq 20%.

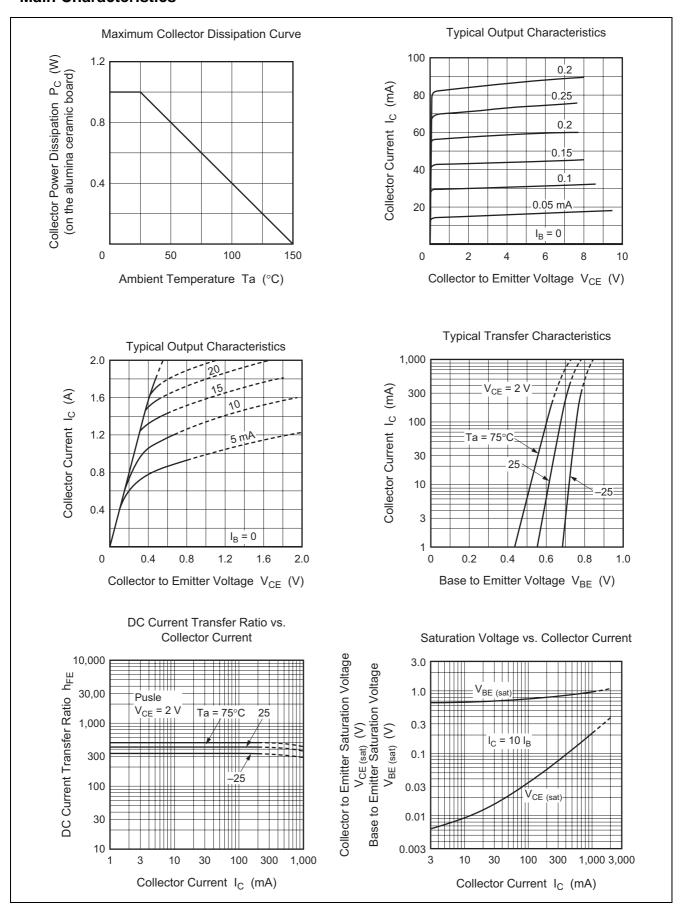
2. Value on the alumina ceramic board (12.5 \times 20 \times 0.7 mm)

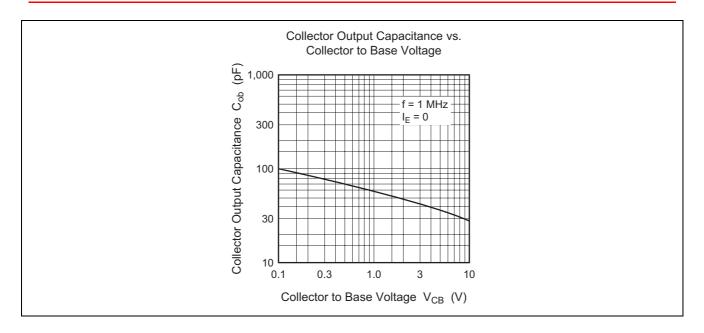
Electrical Characteristics

 $(Ta = 25^{\circ}C)$

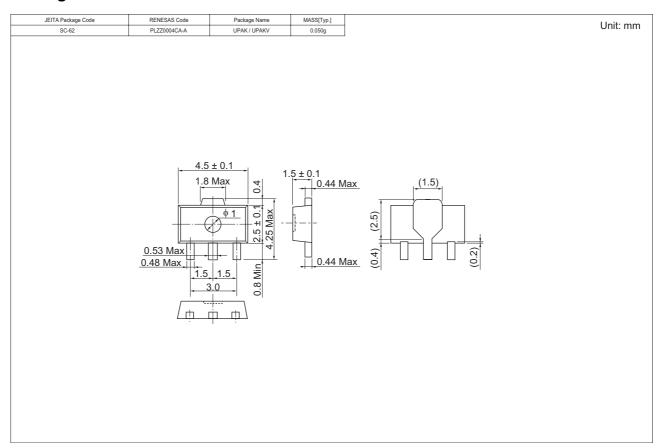
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	V _{(BR)CBO}	20	_	_	V	$I_C = 10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	16	_	_	٧	I_C = 1 mA, R_{BE} = ∞
Emitter to base breakdown voltage	$V_{(BR)EBO}$	6	_	_	V	$I_E = 10 \mu A, I_C = 0$
Collector cutoff current	I _{CBO}		_	0.1	μΑ	$V_{CB} = 16 \text{ V}, I_E = 0$
Emitter cutoff current	I _{EBO}			0.1	μΑ	$V_{EB} = 5 \text{ V}, I_{C} = 0$
DC current transfer ratio	h_FE	250	_	500		$V_{CE} = 2 V$, $I_C = 0.1 A$, Pulse
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$		0.15	0.3	V	$I_C = 1 \text{ A}, I_B = 0.1 \text{ A}, \text{ Pulse}$
Base to emitter saturation voltage	$V_{BE(sat)}$		0.9	1.2	V	$I_C = 1 \text{ A}, I_B = 0.1 \text{ A}, \text{ Pulse}$
Gain bandwidth product	f⊤		100	_	MHz	$V_{CE} = 2 \text{ V}, I_{C} = 10 \text{ mA}$
Collector output capacitance	Cob	_	20	_	pF	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$

Main Characteristics





Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SD1367BCTR-E	1000	φ 178 mm Reel, 12 mm Emboss Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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